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TRA	NSMITTA	L OF INFORMA (Under 37 CFF	Docket No. YOU102					
In Re Application Of: Kim, et al.								
Application No. Filing Date Examiner Customer No. Group Art Unit Confirmation No.								
10/786,379 February 25, 2004 32047 1762 3388								
	Title: NETHOD OF PROTECTING METALS FROM CORROSION USING THIOL COMPOUNDS JAN 1 2 2005							
	Address to: Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450							
			37 CFR 1.97(b)					
1. 🛚	1. A The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application other than a continued prosecution application under 37 CFR 1.53(d); within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; before the mailing of a first Office Action on the merits, or before the mailing of a first Office Action after the filing of a request for continued examination under 37 CFR 1.114.							
37 CFR 1.97(c)								
2.	The Information Disclosure Statement submitted herewith is being filed after the period specified in 37 CFR 1.97(b), provided that the Information Disclosure Statement is filed before the mailing date of a Final Action under 37 CFR 1.113, a Notice of Allowance under 37 CFR 1.311, or an Action that otherwise closes prosecution in the application, and is accompanied by one of:							
☐ the statement specified in 37 CFR 1.97(e);								
OR								
☐ the fee set forth in 37 CFR 1.17(p).								

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT (Under 37 CFR 1.97(b) or 1.97(c))						Docket No. YOU102		
In Re Applicatio	n: Kim, et al.							
Application No. Filing Date Examiner Customer					Group Art Unit	Confirmation No.		
10/786,379	February 25, 2004			32047	1762	3388		
Title: METHOD	OF PROTECTING N		RROSION	USING THIOL	COMPOUNDS			
☐ The Director as describer ☐ Ch☐ ☐ Ch☐ ☐ Payment b☐ ☐ WARNING	the amount of or is hereby authorize	t. ee required. TO-2038 is attached s form may become	ned. dit Deposit A	Account No. 5	50-2121 ormation should	I not be		
Typed or I *This certifie deposit account Donald J. Perreault Reg. No. 40,126	Signature	tion to charge deposit to the United States	I hereby of with the U as first "Commissi 22313-145 Janu Type	certify that this connited States Postaclass mail in inioner for Patents, 10" [37 CFR 1.8(a)] ary 10, 2005 (Date) Signature of Per	Son Mailing Corresponding Corresponding Co	ng deposited cient postage ddressed to exandria, VA		
cc:								

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					Docket Number (optional)		Application No.			
					YOU102		10/	786,379		
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(Use several sheets if necessary)					Kim et al.					
				Filing Date February 25, 2004			Group Art Unit			
13/2			U.S. PA	TENT I	DOCUMENTS					
*Examiner	TRADE					Τ		FILING	G DATE	
Initial	REF	DOCUMENT NUMBER	DATE		NAME	CL	ASS/SUBCLASS	IF APPR	OPRIATE	
		5,108,793	. 04/28/1992	van C	Ooij et al.		427/327	-		
***		5,200,275	04/06/1993	van Ooij et al.		428/623				
		5,292,549	03/08/1994	van Ooij et al.		427/156				
		5,433,976	07/18/1995	van Ooij et al.		427/327				
		5,487,792 01/30/1996 King et al.		et al.		136/256				
		5,750,197	05/12/1998	van Ooij et al.		427/318				
		5,759,629	06/02/1998	van Ooij et al.		427/384				
		6,102,521	08/15/2000	Halk	o et al.		347/47			
		6,183,815 B1	02/06/2001	Enicl	k et al.		427/400			
		6,461,682 B1	10/08/2002	Crott	y et al.		427/387			
			FOREIGN	PATE	NT DOCUMENTS					
	REF DOCUMENT NUMBER DATE		DATE	COUNTRY		CLASS/SUBCLASS		TRANSLATION YES NO		
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		OTHER DO	OCUMENTS (Incl	uding A	uthor, Title, Date, Pertinent	Pages,	Etc.)			
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EXAMINER				DATE CONSIDERED						

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include Copy of this form with next communication to applicant

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· Access	YOU102	10/786,379				
PINFORMATION DISCLOSURE CITATION	Applicants(s)					
(Use several sheets if necessary)	Kim et al.					
JAN 1 2 2005 E	Filing Date	Group Art Unit				
6	February 25, 2004	1762				
OTHER DOCUMENTS (Includi	ng Author, Title, Date, Pertinent Pag	ges, Etc.)				
	varezza, Protective properties of dodecanthiol layers on copper vironments, Langmuir, 17 (2001), pp. 1483-1487.					
	Jennings, G.K. and Paul E. Laibinis, Self-assembled monolayers of alkanethiol on copper provide corrosion resistance in aqueous environments, Colloids and Surface A: Physicochemical and Engineering Aspects, 116 (1996), pp. 105-114.					
	Nozawa, K., H. Nishihara and K. Aramaki, Chemical Modification of Alkanethiol Monolayer for Protecting Iron Against Corrosion, Corrosion Science, 39 (1997), pp. 1625-1639.					
	Nozawa, K. and K. Aramaki, One- and two-dimensional polymer films of modified alkanethiol monolayers for preventing iron from corrosion, Corrosion Science, 41 (1999), pp. 57-73.					
	Sherer, J., M.R. Vogt, O.M. Magnussen and R.J. Behm, Corrosion of alkanethiol-covered Cu(100) surfaces in hydrochloric acid solution studied by <i>in-situ</i> scanning tunneling microscopy, Langmuir, 13 (1997), pp. 7045-7051.					
	Taneichi, D., Reiko Haneda and Kunitsugu Aramaki, A novel modification of an alkanethiol self-assembled monolayer with alkylisocynates to prepare protective films against copper corrosion, Corrosion Science, 43 (2001), pp. 1589-1600.					
	Zamborini, F.P. and R.M. Crooks, Corrosion passivation of gold by n-alkanethiol self-assembled monolayers: Effect of chain length and end group, Langmuir, 14 (1998), pp. 3279-3286.					
van Ooij, W.J. and T. Child, Protecting Metals with	van Ooij, W.J. and T. Child, Protecting Metals with Silane Coupling Agents, Chemtech, 1998, pp. 26-35.					
EXAMINER DATE	E CONSIDERED					
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